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STD65N55F3

Features

| Туре | V _{DSS} | R _{DS(on)} | ۱ _D | Pw |
|------------|------------------|---------------------|----------------|------|
| STD65N55F3 | 55V | <8.5mΩ | 80A | 110W |

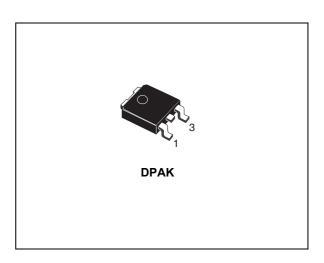
- Standard threshold drive
- 100% avalanche tested

Description

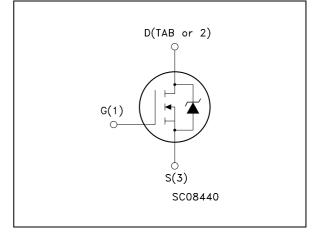
This n-channel enhancement mode Power MOSFET is the latest refinement of STMicroelectronics' unique "Single Feature Size™" strip-based process, which has decreased the critical alignment steps, offering remarkable manufacturing reproducibility. The outcome is a transistor with extremely high packing density for low onresistance, rugged avalanche characteristics and low gate charge.

Applications

- Switching application
 - Automotive



Internal schematic diagram



Order code

| Part number | Marking | Package | Packaging |
|-------------|---------|---------|-------------|
| STD65N55F3 | 65N55F3 | DPAK | Tape & reel |

Contents

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1 Electrical ratings

| Table 1. | Absolute | maximum | ratings |
|----------|----------|---------|---------|
| | | | |

| Symbol | Parameter | Value | Unit |
|------------------------------------|---|------------|------|
| V _{DS} | Drain-source voltage (V _{GS} =0) | 55 | V |
| V _{GS} | Gate-Source voltage | ± 20 | V |
| I _D | Drain current (continuous) at $T_{C} = 25^{\circ}C$ | 80 | A |
| Ι _D | Drain current (continuous) at T _C = 100°C | 56 | A |
| I _{DM} ⁽¹⁾ | Drain current (pulsed) | 320 | А |
| P _{TOT} | Total dissipation at $T_{C} = 25^{\circ}C$ | 110 | W |
| | Derating factor | 0.73 | W/°C |
| dv/dt ⁽²⁾ | Peak diode recovery voltage slope | 11 | V/ns |
| E _{AS} ⁽³⁾ | Single pulse avalanche energy | 390 | mJ |
| T _j T _{stg} | Operating junction temperature Storage temperature | -55 to 175 | °C |

1. Pulse width limited by safe operating area

2. $I_{SD} \leq 65A$, di/dt $\leq 300A/\mu s$, $V_{DD} \leq V_{(BR)DSS}$. Tj \leq Tjmax

3. Starting Tj = 25° C, Id = 32A, Vdd = 25V

| Symbol | Parameter | Value | Unit |
|-------------------------|--------------------------------------|-------|------|
| Rthj-case | Thermal resistance junction-case max | 1.36 | °C/W |
| Rthj-pcb ⁽¹⁾ | Thermal resistance junction-pcb max | 50 | °C/W |

1. When mounted on FR-4 board of 1inch², 2oz Cu.

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

| Table 5. | Static | | | | | |
|----------------------|--|--|------|------|-----------|----------|
| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
| V _{(BR)DSS} | Drain-source breakdown Voltage | I _D = 250μA, V _{GS} = 0 | 55 | | | V |
| I _{DSS} | Zero gate voltage drain current (V _{GS} = 0) | V _{DS} = Max rating, V _{DS} = Max rating,Tc = 125°C | | | 10 100 | μΑ μΑ |
| I _{GSS} | Gate body leakage current (V _{DS} = 0) | $V_{GS} = \pm 20V$ | | | ±200 | nA |
| V _{GS(th)} | Gate threshold voltage | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 2 | | 4 | V |
| R _{DS(on)} | Static drain-source on resistance | V _{GS} = 10V, I _D = 32A | | 6.5 | 8.5 | mΩ |

Table 3. Static

Table 4. Dynamic

| Symbol | Parameter | Test conditions | Min | Тур. | Max. | Unit |
|--|---|--|-----|---------------------|------|----------------|
| g _{fs} ⁽¹⁾ | Forward transconductance | V _{DS} =25V, I _D =32A | | 50 | | S |
| C _{iss} C _{oss} C _{rss} | Input capacitance Output capacitance Reverse transfer capacitance | V _{DS} =25V, f=1MHz, V _{GS} =0 | | 2200 500 25 | | pF pF pF |
| Q _g Q _{gs} Q _{gd} | Total gate charge Gate-source charge Gate-drain charge | V_{DD} =27V, I_D = 65A V_{GS} =10V (see Figure 15) | | 33.5 12.5 9.5 | 45 | nC nC nC |

1. Pulsed: pulse duration = $300\mu s$, duty cycle 1.5%



| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------------------------------|----------------------------------|---|------|------------|------|----------|
| t _{d(on)} t _r | Turn-on delay time Rise time | V_{DD} =27V, I_D = 32A, R_G =4.7 Ω , V_{GS} =10V (see Figure 14) | | 20 50 | | ns ns |
| t _{d(off)} t _f | Turn-off delay time Fall time | V_{DD} =27V, I_D = 32A, R_G =4.7 Ω , V_{GS} =10V (see Figure 14) | | 35 11.5 | | ns ns |

Table 5. Switching on/off (inductive load)

Table 6.Source drain diode

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--|--|--|------|-----------------|-----------|---------------|
| I _{SD} I _{SDM} | Source-drain current Source-drain current (pulsed) ⁽¹⁾ | | | | 80 320 | A A |
| V_{SD} | Forward on voltage | I _{SD} =65A, V _{GS} =0 | | | 1.5 | V |
| t _{rr} Q _{rr} I _{RRM} | Reverse recovery time Reverse recovery charge Reverse recovery current | I _{SD} =65A, di/dt =100A/μs, V _{DD} =25V, Tj=150°C (<i>see Figure 16)</i> | | 47 87 3.7 | | ns nC A |

1. Pulsed: pulse duration = $300\mu s$, duty cycle 1.5%



Electrical characteristics (curves) 2.1

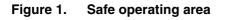
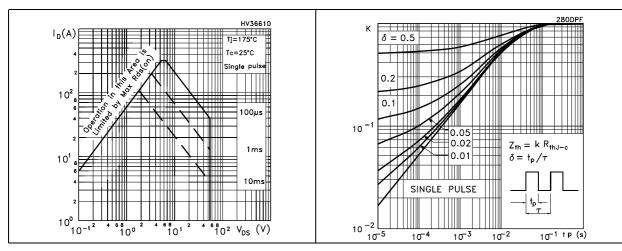
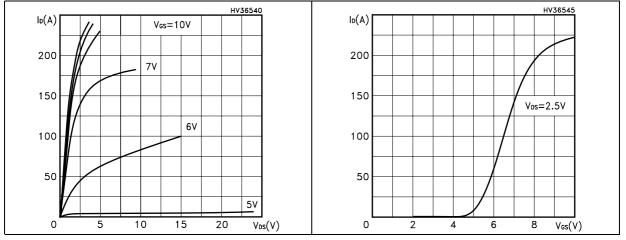


Figure 2. **Thermal impedance**



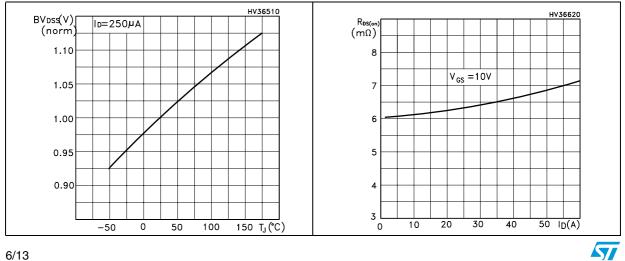








Static drain-source on resistance



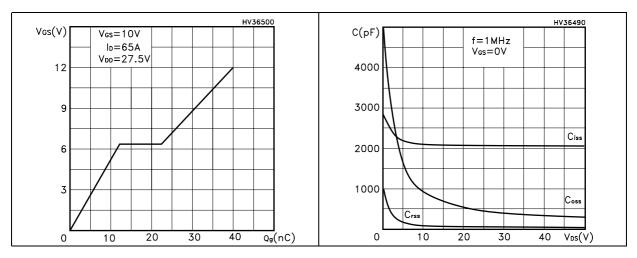
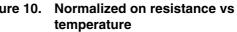


Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

Figure 9. Normalized gate threshold voltage Figure 10. vs temperature



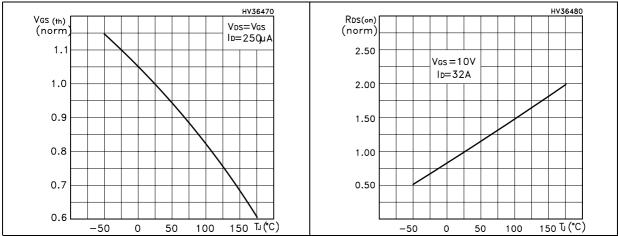
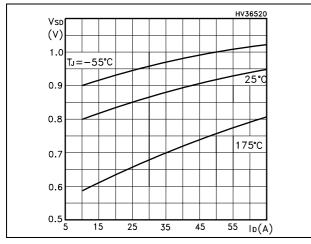


Figure 11. Source-drain diode forward characteristics



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3 Test circuit

Circuit $V_D \longrightarrow U_D \longrightarrow U$

D.U.T.

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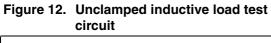
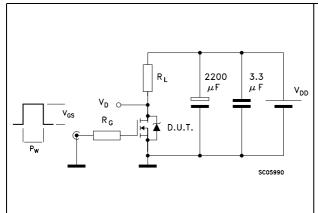
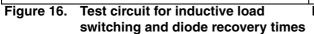


Figure 14. Switching times test circuit for resistive load





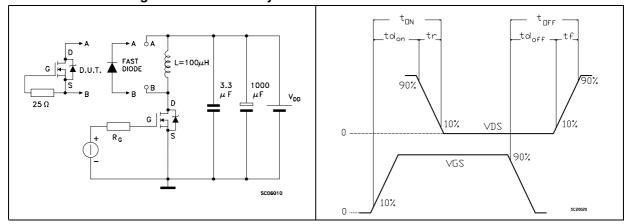
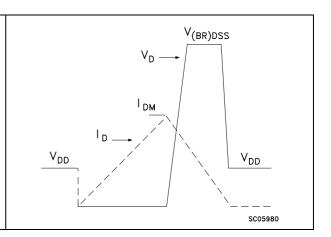
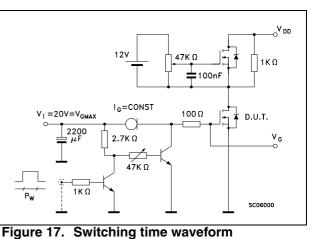


Figure 13. Unclamped inductive waveform







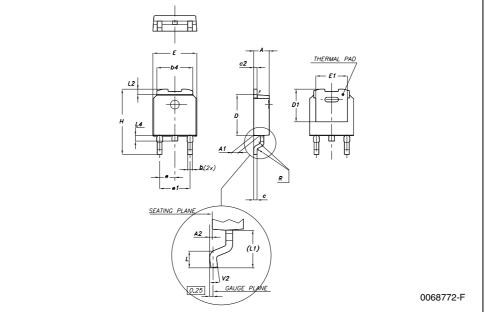
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: *www.st.com*



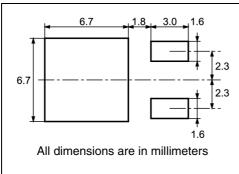
| DIM. | | mm. | | inch | | |
|------|------|------|------|-------|-------|-------|
| | MIN. | ТҮР | MAX. | MIN. | TYP. | MAX. |
| А | 2.2 | | 2.4 | 0.086 | | 0.094 |
| A1 | 0.9 | | 1.1 | 0.035 | | 0.043 |
| A2 | 0.03 | | 0.23 | 0.001 | | 0.009 |
| В | 0.64 | | 0.9 | 0.025 | | 0.035 |
| b4 | 5.2 | | 5.4 | 0.204 | | 0.212 |
| С | 0.45 | | 0.6 | 0.017 | | 0.023 |
| C2 | 0.48 | | 0.6 | 0.019 | | 0.023 |
| D | 6 | | 6.2 | 0.236 | | 0.244 |
| D1 | | 5.1 | | | 0.200 | |
| E | 6.4 | | 6.6 | 0.252 | | 0.260 |
| E1 | | 4.7 | | | 0.185 | |
| е | | 2.28 | | | 0.090 | |
| e1 | 4.4 | | 4.6 | 0.173 | | 0.181 |
| Н | 9.35 | | 10.1 | 0.368 | | 0.397 |
| L | 1 | | | 0.039 | | |
| (L1) | | 2.8 | | | 0.110 | |
| L2 | | 0.8 | | | 0.031 | |
| L4 | 0.6 | | 1 | 0.023 | | 0.039 |
| R | | 0.2 | | | 0.008 | |

DPAK MECHANICAL DATA



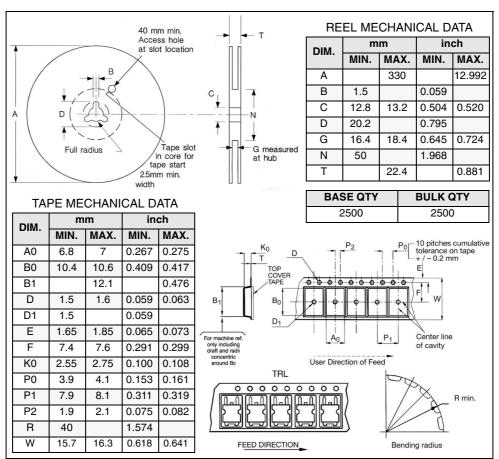


5 Packaging mechanical data



DPAK FOOTPRINT

TAPE AND REEL SHIPMENT



6 Revision history

| Date | Revision | Changes |
|-------------|----------|------------------------------|
| 08-Feb-2007 | 1 | First release |
| 22-Feb-2007 | 2 | Description has been changed |
| 11-May-2007 | 3 | Improved current values |



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